

# RF SWITCH CG2179M2

# L, S-band Medium Power SPDT Switch

### **DESCRIPTION**

The CG2179M2 is a pHEMT GaAs SPDT (<u>Single Pole Double Throw</u>) switch. This device can operate from 0.05 GHz to 3.0GHz, having low insertion loss and high isolation.

#### **FEATURES**

- Control voltage:
   VC(H) = 1.8 to 5.0 V (3.0 V TYP.)
   VC(L) = -0.2 to 0.2 V (0 V TYP.)
- Low insertion loss:

 $\begin{array}{l} L_{ins}1 = 0.30 \text{ dB TYP.} @ f = 0.05 \text{ to } 0.5 \text{ GHz} \\ L_{ins}2 = 0.30 \text{ dB TYP.} @ f = 0.5 \text{ to } 1.0 \text{ GHz} \\ L_{ins}3 = 0.40 \text{ dB TYP.} @ f = 1.0 \text{ to } 2.0 \text{ GHz} \\ L_{ins}4 = 0.45 \text{ dB TYP.} @ f = 2.0 \text{ to } 2.5 \text{ GHz} \\ L_{ins}5 = 0.45 \text{ dB TYP.} @ f = 2.5 \text{ to } 3.0 \text{ GHz} \end{array}$ 

High isolation :

ISL1 = 39 dB TYP. @ f = 0.05 to 0.5 GHz ISL2 = 33 dB TYP. @ f = 0.5 to 1.0 GHz ISL3 = 27 dB TYP. @ f = 1.0 to 2.0 GHz ISL4 = 26 dB TYP. @ f = 2.0 to 2.5 GHz ISL5 = 23 dB TYP. @ f = 2.5 to 3.0 GHz

Power handling :

 $P_{in(0.5dB)} = +32 \text{ dBm TYP.} @ f = 3.0 \text{ GHz}, VC(H) = 3.0 \text{ V}, VC(L) = 0 \text{ V}$ 

# **PACKAGE**

 6-pin mini mold Package (2.0mm x 1.25mm x 0.9mm)



#### **APPLICATIONS**

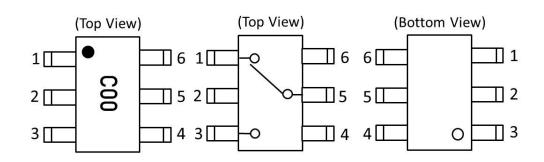
- Wireless LAN (IEEE 802.11 b/g/n/ac)
- Bluetooth

#### ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Description
CG2179M2	CG2179M2-C4	6-pin mini mold package (Pb-Free)	C00	<ul> <li>Embossed tape 8 mm wide</li> <li>Pin 4, 5, 6 face the perforation side of the tape</li> <li>MOQ 10 kpcs/reel</li> </ul>
CG2179M2-EVAL	CG2179M2-EVAL			Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors     MOQ 1



# PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	VC2
5	RFC
6	VC1

# TRUTH TABLE

VC1	VC2	RFC-RF1	RFC-RF2
Low	High	ON	OFF
High	Low	OFF	ON

# **ABSOLUTE MAXIMUM RATINGS**

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Control Voltage	VC	6.0 <sup>Note 1</sup>	V
Input Power	P <sub>in</sub>	+33 <sup>Note 2</sup>	dBm
Operating Ambient Temperature	T <sub>A</sub>	-45 ~ <b>+</b> 85	°C
Storage Temperature	T <sub>stg</sub>	-55 ~ <b>+</b> 150	°C

**Note** 1.  $|VC1 - VC2| \le 6.0V$ 

2.  $3.0V \le |VC1 - VC2| \le 5.0V$ ,  $f \ge 0.5GHz$ 

# RECOMMENDED OPERATING RANGE

(TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.05	-	3.0	GHz
Switch Control Voltage (H)	VC(H)	+1.8	+3.0	+5.0	V
Switch Control Voltage (L)	VC(L)	-0.2	0	+0.2	V



# **ELECTRICAL CHARACTERISTICS**

 $(TA = +25^{\circ}C, VC(H) = 3.0V, VC(L) = 0V, Zo = 50\Omega, DC Block Capacitance = 56pF, unless otherwise specified)$ 

	•	·	•		•	•
Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
Insertion Loss	L <sub>INS</sub> 1	f=0.05 to 0.5GHz Note 1		0.30	0.50	dB
	L <sub>INS</sub> 2	f=0.5 to 1.0GHz		0.30	0.50	dB
	L <sub>INS</sub> 3	f=1.0 to 2.0GHz		0.40	0.60	dB
	L <sub>INS</sub> 4	f=2.0 to 2.5GHz		0.45	0.65	dB
	L <sub>INS</sub> 5	f=2.5 to 3.0GHz		0.45	0.65	dB
Isolation	ISL1	f=0.05 to 0.5GHz Note 1	36	39		dB
	ISL2	f=0.5 to 1.0GHz	30	33		dB
	ISL3	f=1.0 to 2.0GHz	23	27		dB
	ISL4	f=2.0 to 2.5GHz	22	26		dB
	ISL5	f=2.5 to 3.0GHz	21	24		dB
Input Return Loss	RL <sub>in</sub> 1	f=0.05 to 0.5GHz Note 1	15	20		dB
	RL <sub>in</sub> 2	f=0.5 to 3.0GHz	15	20		dB
Output Return Loss	RL <sub>out</sub> 1	f=0.05 to 0.5GHz Note 1	15	20		dB
	RL <sub>out</sub> 2	f=0.5 to 3.0GHz	15	20		dB
0.1dB Loss Compression Input Power	P <sub>in(0.1dB)</sub>	f=3.0GHz, VC(H)=1.8V, VC(L)=0V		+23		dBm
Note 2		f=3.0GHz, VC(H)=3.0V, VC(L)=0V		+30		dBm
0.5dB Loss Compression Input Power	P <sub>in(0.5dB)</sub>	f=3.0GHz, VC(H)=1.8V, VC(L)=0V		+26		dBm
Note 3		f=3.0GHz, VC(H)=3.0V, VC(L)=0V		+32		dBm
2nd Harmonics	2f0	f=3.0GHz, P <sub>in</sub> =+20dBm		-85		dBc
3rd Harmonics	3f0	f=3.0GHz, P <sub>in</sub> =+20dBm		-85		dBc
3rd Order Input Intercept Point	IIP <sub>3</sub>	f=2.5GHz, 2-tone 1MHz Spacing		+58		dBm
Switch Control Current	I <sub>CONT</sub>	RF none		1	10	uA
Switching Speed	t <sub>SW</sub>	50% CTL to 90/10% RF		50		ns

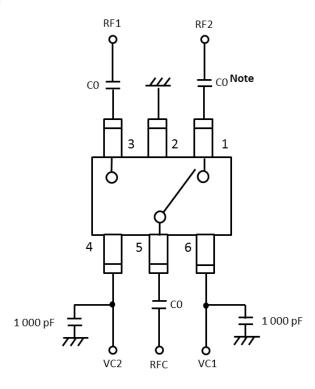
Note 1. DC block capacitance = 1000pF at f=0.05 to 0.5GHz

<sup>2.</sup>  $P_{in(0.1dB)}$  is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

<sup>3.</sup>  $P_{in(0.5dB)}$  is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range



# **EVALUATION CIRCUIT**

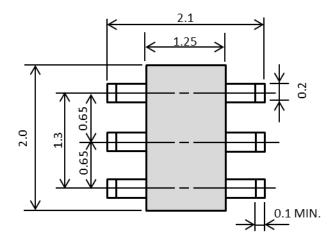


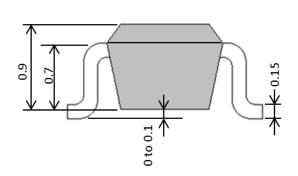
**Note** C0 : 0.05 to 0.5 GHz 1000pF : 0.5 to 3.0 GHz 56pF

The application circuits and their parameters are for reference only and are not intended for use in actual designs. DC Blocking Capacitors are required at all RF ports.

# **PACKAGE DIMENSIONS**

6-pin mini mold package (Unit: mm)







# **REVISION HISTORY**

Version	Change to current version	Page(s)
CDS-0008-03 (Issue A) February 17, 2016	Initial datasheet	N/A
CDS-0008-03 (Issue B) March 24, 2016	Added Eval Board ordering information Updated Marking information	1, 2
CDS-0008-03 (Issue C) August 11, 2016	Removed "Preliminary"	All



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- Do not chemically make gas or powder with this product.
- When discarding this product, please obey the laws of your country.
- Do not lick the product or in any way allow it to enter the mouth.

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